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# GBPC1000 THRU GBPC5010

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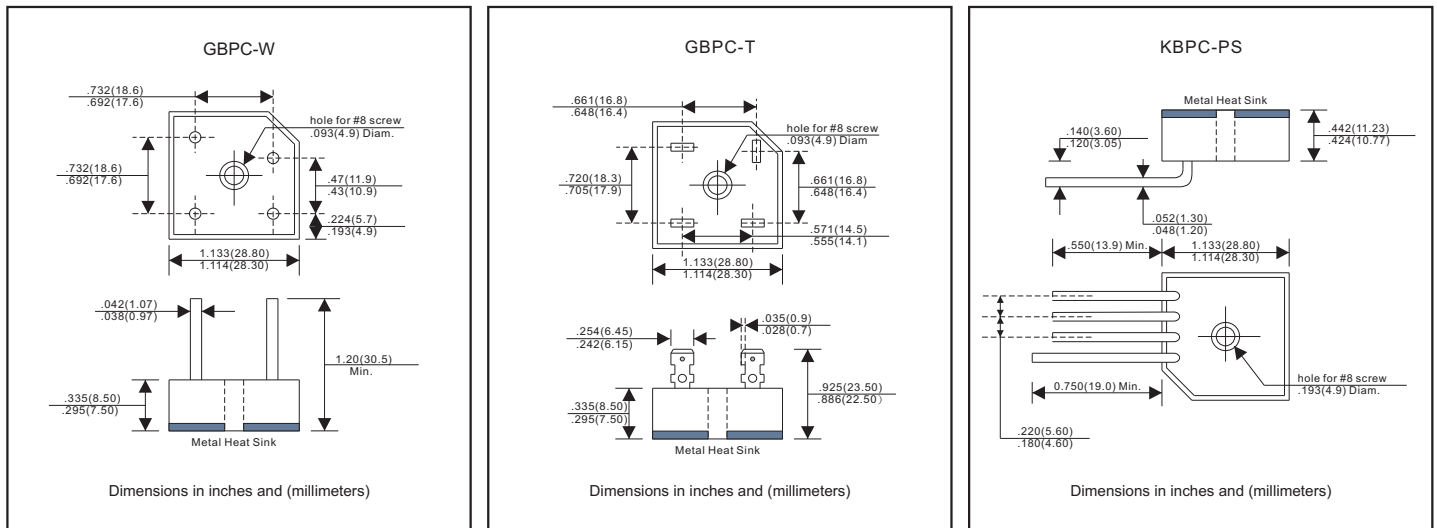
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## GBPC1000 THRU GBPC5010

10.0A ~ 50.0A Glass Passivated Single-Phase Bridge Rectifiers - 50V-1000V

### Package outline



### Features

- Surge overload ratings to 450 amperes peak.
- Low Forward drop voltage & reverse leakage current.
- Integrally molded heatsink provides very low thermal Resistance for maximum heat dissipation
- Universal 3-way terminals for selection, faston terminals wire leads and wire-lead single in line.
- Glass passivated chip junctions.
- Lead-free parts meet RoHS requirements.
- UL recognized file # E321971

### Mechanical data

- Epoxy:UL94-V0 rated flame retardant
- Case : Molded plastic, GBPC case with heatsink
- Terminals : Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity : marked on side body
- Mounting Position : Hole thru for #10 screw(Note A)
- Mounting Torque: 20 in-lb (23cm-kg) max.
- Weight : GBPC-W , 0.53 ounce, 15 grams  
GBPC-T, 0.63 ounce, 18 grams  
KBPC-PS, 0.63 ounce, 18 grams

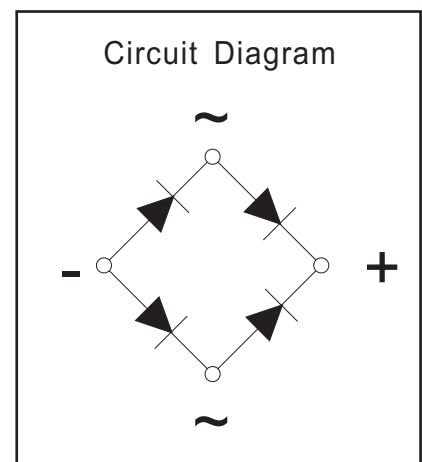
### Part Numbering

GBPC1001-T

Lead Types,  
T : faston terminals  
W : wire leads  
S : wire-lead single in line

Reverse Voltage,  
00: 50V 01: 100V 02: 200V  
04: 400V 06: 600V 08: 800V  
10: 1000V 12: 1200V

Forward Rectified Output Current,  
10: 10.0A 15: 15.0A 25: 25.0A  
35: 35.0A 40: 40.0A 50: 50.0A



# GBPC1000 THRU GBPC5010

**Maximum ratings** (AT  $T_A=25^{\circ}\text{C}$  unless otherwise noted)

GBPCXX, XX=10, 15, 25, 35, 40 or 50		Symbols	GBPC xx00	GBPC xx01	GBPC xx02	GBPC xx04	GBPC xx06	GBPC xx08	GBPC xx10	Unit
Maximum Recurrent Peak Reverse Voltage		VRRM	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage		VRMS	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage		VDC	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Output Current (See Fig. 1)	GBPC10	I(AV)	10.0							Amps
	GBPC15		15.0							
	GBPC25		25.0							
	GBPC35		35.0							
	GBPC40		40.0							
	GBPC50		50.0							
Peak Forward Surge Current 8.3mS single half sine-wave superimposed on rated load (JEDEC Method)	GBPC10	IFSM	200							Amps
	GBPC15		300							
	GBPC25		300							
	GBPC35		400							
	GBPC40		400							
	GBPC50		450							
Rating (Non-Repetitive, for t greater than 1ms and less than 8.3ms) for fusing	GBPC10	I <sup>2</sup> t	166							A <sup>2</sup> sec
	GBPC15		374							
	GBPC25		374							
	GBPC35		664							
	GBPC40		664							
	GBPC50		840							
Maximum Instantaneous Forwarded Voltage Drop Per Leg at	GBPC10 IF= 5.0A	VF	1.1							Volts
	GBPC15 IF= 7.5A									
	GBPC25 IF=12.5A									
	GBPC35 IF=17.5A									
	GBPC40 IF=20.0A									
	GBPC50 IF=25.0A									
Maximum DC Reverse Current at Rated DC Blocking Voltage	TJ= 25°C	IR	5.0							μA
	TJ=125°C		500.0							
Operating Junction Temperature Range		TJ	-55 ~ +150							°C
Storage Temperature Range		TSTG	-65 ~ +150							°C

## Rating and characteristic curves (GBPC1000 THRU GBPC5010)

Fig. 1 - Derating Curve Output Rectified Current

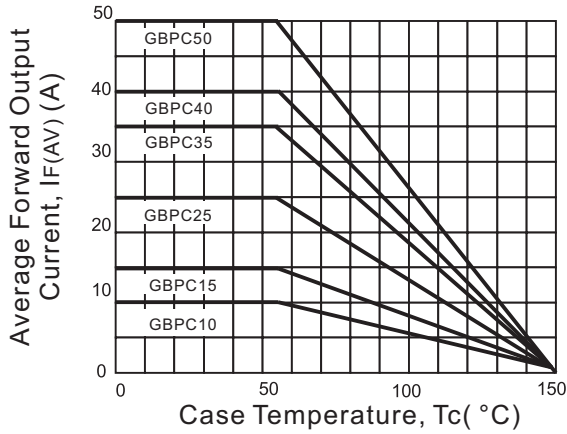


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

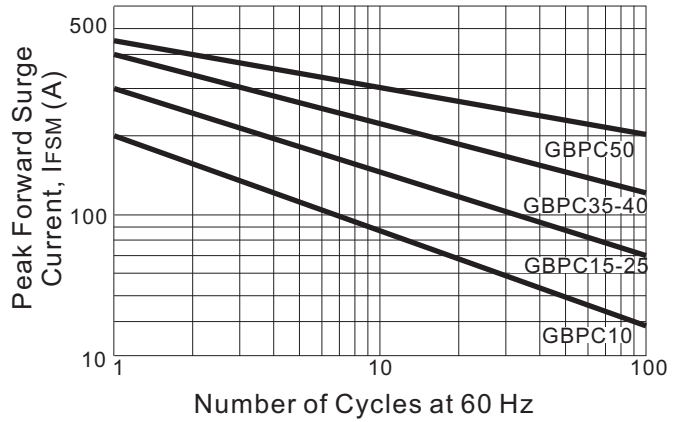


Fig. 3 - Typical Instantaneous Forward Characteristics (Per Leg)

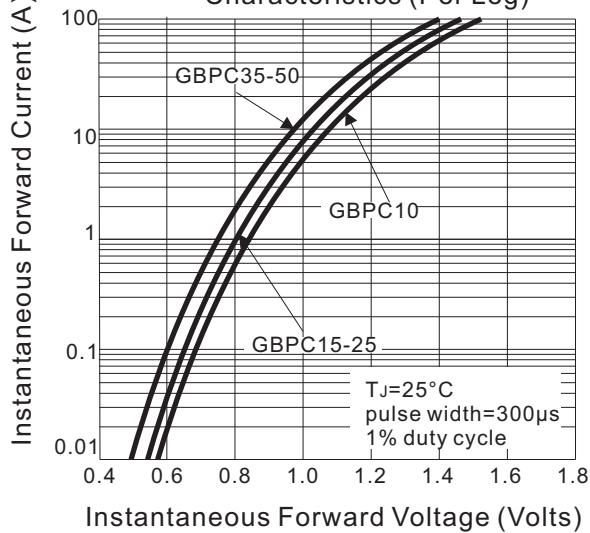
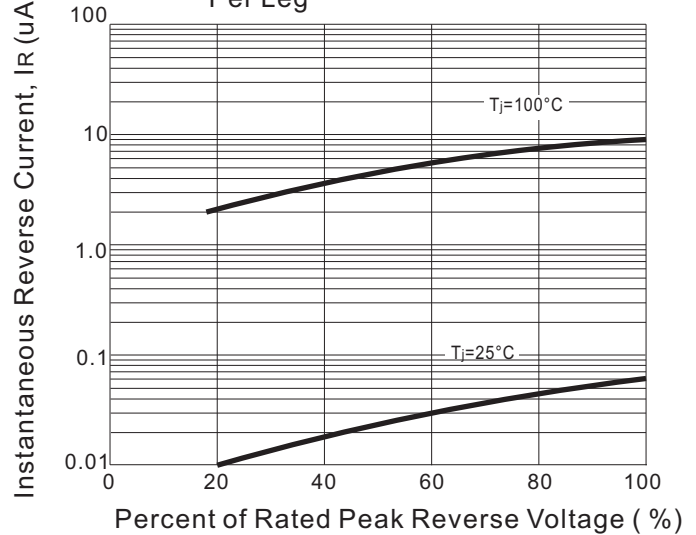


Fig. 4 - Typical Reverse Characteristics Per Leg



### Marking

Type number	Marking code
GBPCXX00	GBPCXX00
GBPCXX01	GBPCXX01
GBPCXX02	GBPCXX02
GBPCXX04	GBPCXX04
GBPCXX06	GBPCXX06
GBPCXX08	GBPCXX08
GBPCXX10	GBPCXX10

XX=10, 15, 25, 35, 40, or 50

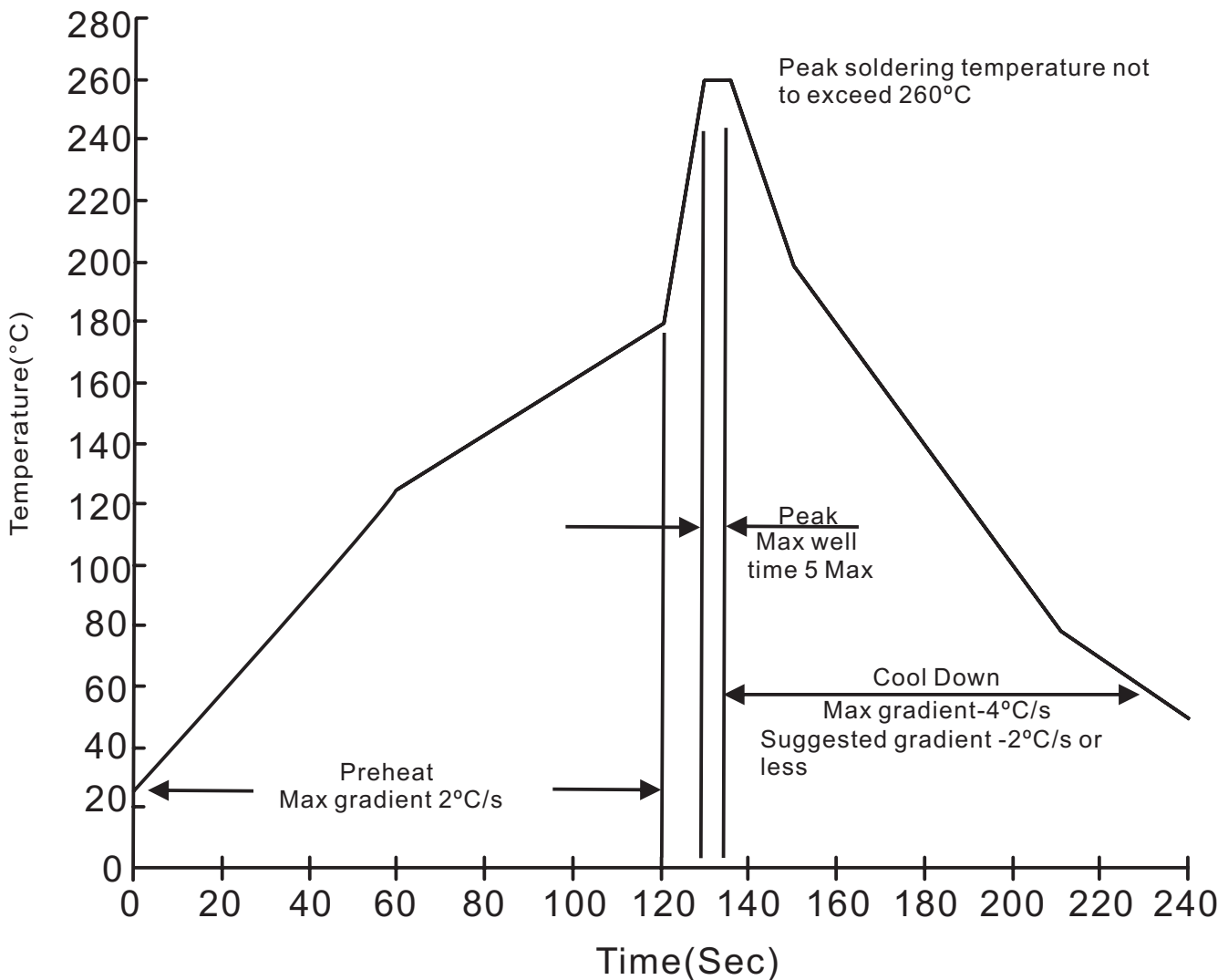
# GBU1000 THRU GBPC5010

## BULK PACKING

DEVICE CASE TYPE	Q'TY 1 (PCS / BOX)	INNER BOX SIZE (m/m)	CARTON SIZE (m/m)	Q'TY 2 (PCS / CARTON)	APPROX. CROSS WEIGHT(kg)
GBPC-T	50	203 * 203 * 44	445 * 215 * 260	500	8.0
GBPC-W	50	203 * 203 * 44	445 * 215 * 260	500	9.0
KBPC-S	120	203 * 203 * 44	445 * 215 * 260	1,200	22.0

### Suggested thermal profiles for soldering processes

#### 1. Lead free temperature profile wave-soldering



**GBPC1000 THRU GBPC5010****High reliability test capabilities**

Item Test	Conditions	Reference
1. Solder Resistance	at $260\pm 5^{\circ}\text{C}$ for $10\pm 2\text{sec.}$ immerse body into solder $1/16''\pm 1/32''$	MIL-STD-750D METHOD-2031
2. Solderability	at $245\pm 5^{\circ}\text{C}$ for 5 sec.	MIL-STD-202F METHOD-208
3. High Temperature Reverse Bias	$V_R=80\%$ rate at $T_J=125^{\circ}\text{C}$ for 168 hrs.	MIL-STD-750D METHOD-1038
4. Forward Operation Life	Rated average rectifier current at $T_A=25^{\circ}\text{C}$ for 500hrs.	MIL-STD-750D METHOD-1027
5. Intermittent Operation Life	$T_A = 25^{\circ}\text{C}$ , $I_F = I_o$ On state: power on for 5 min. off state: power off for 5 min. on and off for 500 cycles.	MIL-STD-750D METHOD-1036
6. Pressure Cooker	$15P_{SIG}$ at $T_A=121^{\circ}\text{C}$ for 4 hrs.	JESD22-A102
7. Temperature Cycling	$-55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ dwelled for 30 min. and transferred for 5min. total 10 cycles.	MIL-STD-750D METHOD-1051
8. Thermal Shock	$0^{\circ}\text{C}$ for 5 min. rise to $100^{\circ}\text{C}$ for 5 min. total 10 cycles.	MIL-STD-750D METHOD-1056
9. Forward Surge	8.3ms single half sine-wave superimposed on rated load, one surge.	MIL-STD-750D METHOD-4066-2
10. Humidity	at $T_A=85^{\circ}\text{C}$ , RH=85% for 1000hrs.	MIL-STD-750D METHOD-1021
11. High Temperature Storage Life	at $175^{\circ}\text{C}$ for 1000 hrs.	MIL-STD-750D METHOD-1031